

STGB10NC60K

10 A, 600 V short-circuit rugged IGBT

Features

- Low on voltage drop (V_{CESAT})
- Short-circuit withstand time 10 µs

Applications

- High frequency motor controls
- SMPS and PFC in both hard switch and resonant topologies
- Motor drives

Description

This device utilizes the advanced Power MESH[™] process resulting in an excellent trade-off between switching performance and low on-state behavior.

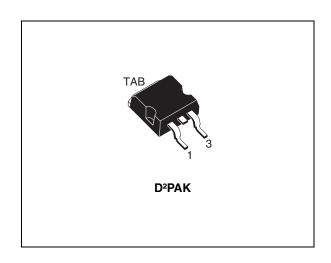


Figure 1. Internal schematic diagram

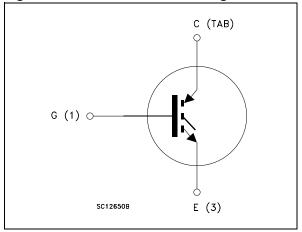


Table 1. Device summary

Part number	Part number Marking		Packaging	
STGB10NC60KT4	GB10NC60K	D ² PAK	Tape and reel	

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Electrical ratings STGB10NC60K

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{CES}	Collector-emitter voltage (V _{GE} = 0)	600	V
I _C ⁽¹⁾	Continuous collector current at T _C = 25°C	20	Α
I _C ⁽¹⁾	Continuous collector current at T _C = 100°C	10	Α
I _{CL} (2)	Turn-off latching current	30	Α
I _{CP} (3)	Pulsed collector current	30	Α
V _{GE}	Gate-emitter voltage	±20	V
P _{TOT}	Total dissipation at T _C = 25°C	65	W
T _{STG}	Storage temperature	- 55 to 150 °c	
T _J	Operating junction temperature	- 55 10 150	°C
t _{SCW}	Short-circuit withstand time ($V_{CE} = 0.5 V_{CES}$, $T_J = 125 ^{\circ}C$, $R_G = 10 \Omega$, $V_{GE} = 12 V$)		μs

^{1.} Calculated according to the iterative formula:

$$I_{C}(T_{C}) = \frac{T_{j(max)} - T_{C}}{R_{thj-c} \times V_{CE(sat)(max)}(T_{j(max)}, I_{C}(T_{C}))}$$

- 2. V_{clamp} = 80 % V_{CES} , V_{GE} = 15 V, R_{G} = 10 Ω , T_{J} = 150 °C
- 3. Pulse width limited by maximum junction temperature and turn-off within RBSOA

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{thJC}	Thermal resistance junction-case	1.9	°C/W
R _{thJA}	Thermal resistance junction-ambient	62.5	°C/W

2 Electrical characteristics

 T_J = 25 $^{\circ}C$ unless otherwise specified.

Table 4. Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)CES}	Collector-emitter breakdown voltage (V _{GE} = 0)	I _C = 1mA	600			V
V _{CE(sat)}	Collector-emitter saturation	V _{GE} = 15V, I _C = 5A		2.2	2.5	٧
• CE(sat)	voltage	V _{GE} = 15V, I _C = 5A, T _J =125°C		1.8		V
$V_{GE(th)}$	Gate threshold voltage	$V_{CE} = V_{GE}$, $I_{C} = 250 \mu A$	4.5		6.5	V
1	Collector cut-off current	V _{CE} = 600 V			150	μΑ
I _{CES}	$(V_{GE} = 0)$	$V_{CE} = 600 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$			1	mA
I _{GES}	Gate-emitter leakage	V _{GF} = ± 20 V			±100	nA
IGES	current (V _{CE} = 0)	VGE- ± 20 V			±100	ш
9 _{fs} ⁽¹⁾	Forward transconductance	$V_{CE} = 15 V_{,} I_{C} = 5A$		15		S

^{1.} Pulse test: pulse duration < 300 μ s, duty cycle < 2 %.

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{ies} C _{oes} C _{res}	Input capacitance Output capacitance Reverse transfer capacitance	$V_{CE} = 25V$, $f = 1MHz$, $V_{GE} = 0$		380 46 8.5		pF pF pF
Q _g Q _{ge} Q _{gc}	Total gate charge Gate-emitter charge Gate-collector charge	V_{CE} = 390V, I_{C} = 5A, V_{GE} = 15V, (see Figure 17)		19 5 9		nC nC nC

Table 6. Switching on/off (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	V_{CC} = 390V, I_{C} = 5A R_{G} = 10 Ω , V_{GE} = 15V, (see Figure 18)		17 6 655		ns ns A/µs
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	V_{CC} = 390V, I_{C} = 5A R_{G} = 10 Ω , V_{GE} = 15V, Tj=125°C (see Figure 18)		16.5 6.5 575		ns ns A/µs
$\begin{array}{c} t_{\rm f}({\rm V}_{\rm off}) \\ t_{\rm d}(_{\rm off}) \\ t_{\rm f} \end{array}$	Off voltage rise time Turn-off delay time Current fall time	$V_{cc} = 390V, I_C = 5A,$ $R_{GE} = 10\Omega, V_{GE} = 15V,$ (see Figure 18)		33 72 82		ns ns ns
$\begin{array}{c} t_{r}(V_{off}) \\ t_{d}(_{off}) \\ t_{f} \end{array}$	Off voltage rise time Turn-off delay time Current fall time	V_{cc} = 390V, I_{C} = 5A, R_{GE} =10 Ω , V_{GE} =15V, Tj=125°C (see Figure 18)		60 106 136		ns ns ns



Electrical characteristics STGB10NC60K

Iab	<i>ne 1</i> .	Switching energy (inc	ductive load)				
Sy	mbol	Parameter	Test conditions	Min	Тур	Max	Unit
E	: (1) on (2) off E _{ts}	Turn-on switching losses Turn-off switching losses Total switching losses	V_{CC} = 390V, I_{C} = 5A R_{G} = 10 Ω , V_{GE} =15V, (see Figure 18)		55 85 140		μJ μJ μJ
E	(1) on (2) off E _{ts}	Turn-on switching losses Turn-off switching losses Total switching losses	$V_{CC} = 390V, I_{C} = 5A$ $R_{G} = 10\Omega, V_{GE} = 15V,$ $Tj = 125^{\circ}C$ (see Figure 18)		87 162 249		μJ μJ μJ

Table 7. Switching energy (inductive load)

2.1 Electrical characteristics (curves)

Figure 2. Output characteristics

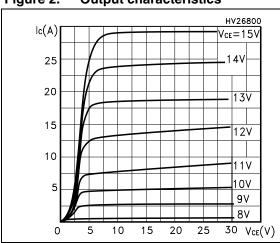


Figure 3. Transfer characteristics

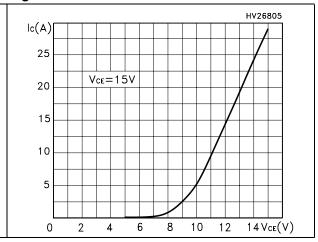
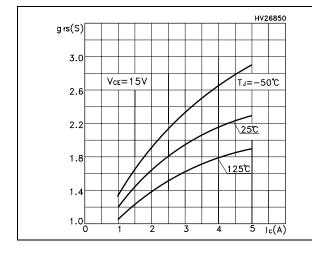
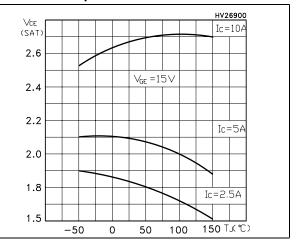


Figure 4. Transconductance

Figure 5. Collector-emitter on voltage vs temperature





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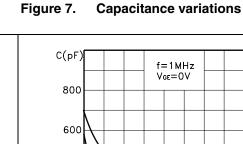
Eon is the tun-on losses when a typical diode is used in the test circuit in figure 2. If the IGBT is offered in a
package with a co-pak diode, the co-pack diode is used as external diode. IGBTs & Diode are at the same
temperature (25°C and 125°C)

^{2.} Turn-off losses include also the tail of the collector current

HV26780

Ciss

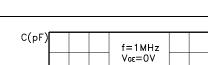
Figure 6. Gate charge vs. gate-source voltage



400

200

0



Coss

10

20

30

40 Vce(V)

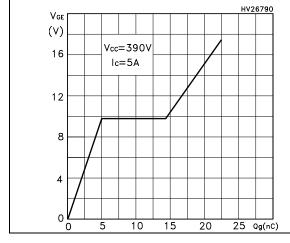
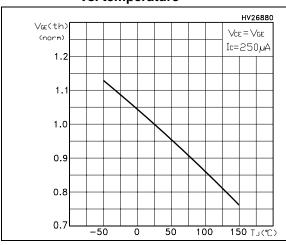


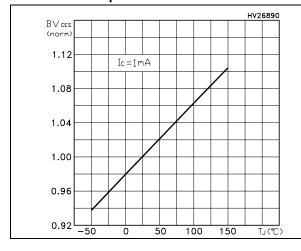
Figure 8. Normalized gate threshold voltage Figure 9. Collector-emitter on voltage vs vs. temperature collector current

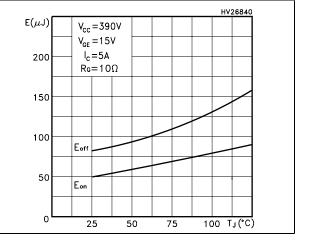


HV26870 VCE(SAT) (V) 3.5 3.0 2.5 2.0 25°C 1.5 TJ=125°C 1.0 0.5L 3 6 9 12 15 Ic(A)

Figure 10. Normalized breakdown voltage vs temperature

Figure 11. Switching losses vs temperature

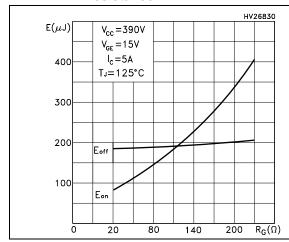




Electrical characteristics STGB10NC60K

Figure 12. Switching losses vs. gate resistance

Figure 13. Switching losses vs collector current



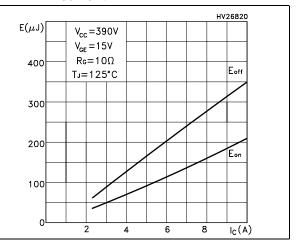
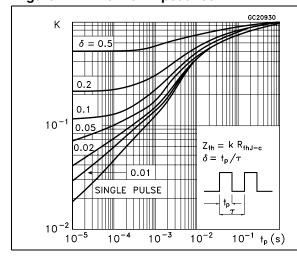
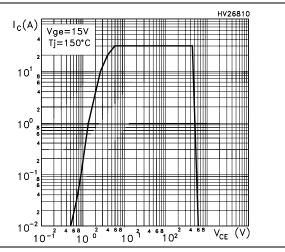


Figure 14. Thermal impedance

Figure 15. Turn-off SOA





STGB10NC60K Test circuits

3 Test circuits

Figure 16. Test circuit for inductive load switching

Figure 17. Gate charge test circuit

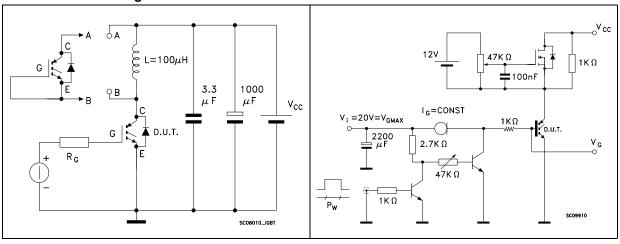
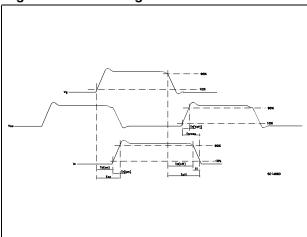


Figure 18. Switching waveform



4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

Table 8. D²PAK (TO-263) mechanical data

Dim.		mm	
Dim.	Min.	Тур.	Max.
А	4.40		4.60
A1	0.03		0.23
b	0.70		0.93
b2	1.14		1.70
С	0.45		0.60
c2	1.23		1.36
D	8.95		9.35
D1	7.50		
E	10		10.40
E1	8.50		
е		2.54	
e1	4.88		5.28
Н	15		15.85
J1	2.49		2.69
L	2.29		2.79
L1	1.27		1.40
L2	1.30		1.75
R		0.4	
V2	0°		8°

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SEATING PLANE
COPLANARITY A1

R

GAUGE PLANE

V2

0079457_R

Figure 19. D²PAK (TO-263) drawing

57

Revision history STGB10NC60K

5 Revision history

Table 9. Document revision history

Date	Revision	Changes
21-Nov-2005	1	New release
06-Dic-2005	2	Inserted row on Table 2: Absolute maximum ratings
08-Feb-2007	3	Description has been updated
24-Feb-2011	4	Updated package mechanical data <i>Table 8. on page 8</i> and <i>Figure 19. on page 9</i>

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